Miniature Microwave Bandpass Filter Based on EBG Structures

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Abstract — A new design of a planar microwave filter, based on rejection band properties of an electrically small electromagnetic bandgap (EBG) structure, is proposed. The proposed EBG structure demonstrates effective impedance manipulation, exhibits a simple analysis, and is about three times smaller as compared to stepped-impedance hairpin (SIH) resonators with similar response. The new bandpass filter has a reduced footprint and can be fabricated in standard thick-film manufacturing technology. Measured and simulated results exhibit good agreement. The measured results show improvement in the filter characteristics in comparison to existing SIH filter design.

Index Terms — Electromagnetic bandgap, microstrip, microwave filter, slow-wave effect.

I. INTRODUCTION

Compact, high-performance microwave filters are essential for high-efficiency miniaturized microwave systems. The filter circuit size is large in traditionally designed planar bandpass filters due to a high number of large area resonators. The rejection level in the upper stopband of the filters is usually degraded by the spurious response at twice the passband frequency. Several types of resonators have been designed to overcome these problems, such as miniaturized hairpin resonators, stepped-impedance hairpin resonators, and slow-wave open-loop resonators. Coupled transmission line sections are frequently used today for the realization of compact matching circuits to various devices [1, 2].

Miniaturized resonators lead to a reduced filter size, but not always improve the spurious response. Another method relies on various resonator realizations within one filter structure to reduce the circuit size, such as the coupled line filter with SIH resonator proposed by Wang et al. [3]. Two coupled line resonators loaded by the stepped-impedance hairpin resonator are employed in this filter. The performance of the filter can be significantly enhanced by carefully adjusting the load impedances of the coupled line sections.

The load impedance adjustment can also be achieved by implementing slow-wave EBG structures, which reduces the length of the microwave resonator and contributes to the filter miniaturization [4, 5].

This paper proposes an EBG structure exhibiting a lowpass, slow-wave characteristic for impedance manipulation of reduced size bandpass filters. A combination of slow-wave EBG structures and coupled line resonators leads to compact bandpass filters, exhibiting improved stopband characteristics. As an example this paper presents measured and simulated results for a high performance reduced dimension bandpass filter in comparison to existing filter types.

II. MICROSTRIP EBG STRUCTURE

It is generally assumed that EBG structures give rise to large area filters, as has been shown by various groups [6, 7]. However, compact slow-wave EBG structures can be realized in a form of a periodically loaded transmission line. The proposed pattern for a microstrip line is shown in Fig. 1.

![Periodically loaded microstrip transmission line section used as a slow-wave EBG structure.](image)

Fig. 1. Periodically loaded microstrip transmission line section used as a slow-wave EBG structure.

The concept of the filter behavior can be explained by considering relations for the transmission line. As can be seen in Fig. 1, the EBG structure consists on a high impedance microstrip line with characteristic impedance $Z_{\text{TRL}}$ given by

$$Z_{\text{TRL}} = \sqrt{\frac{L_{\text{TRL}}}{C_{\text{TRL}}}},$$

where $C_{\text{TRL}}$ is the capacitance per unit length and $L_{\text{TRL}}$ is the inductance per unit length of the line. The high impedance transmission line is loaded by a patch with width $W_p$ and length $l_p$ using short transversal stubs. In this configuration the most significant contribution to the equivalent capacitance of the EBG structure comes from the parallel plate capacitance of the patch, which can be obtained by

$$C_p = \frac{e_r e_0 W_p}{h},$$

where $e_0 = 8.85 \cdot 10^{-12}$ F/m, $e_r$ is the relative permittivity, and $h$ is the thickness of the substrate in Fig. 1.

The characteristic impedance of the resulting structure can be estimated by:
The quantities $C_{TRL}$ and $Z_{TRL}$ are calculated using the well-known relations for microstrip lines. Obviously, $C_p$ and $L_{TRL}$ have the most significant influence on the characteristics of the EBG section. The inductance $L_{TRL}$ is adjusted by varying the transmission line width $W_{TRL}$ whereas the capacitance $C_p$ can be adjusted by varying the parameter $W_p$. By tuning these parameters and the microstrip section length $l_p$, different slow-wave effects can be attained at different frequencies. The operating frequency bandwidth depends on the number of transversal stubs. The feeding lines, which connect the structure to the 50 Ohm load, should be also taken into account because they have an influence on parameters of the structure.

An advantage of this EBG structure is that no etching nor via holes are required in the ground metallization or in the substrate, respectively. Therefore, this technique is compatible with planar fabrication techniques and simplifies the filter design process.

Using such a structure the self-capacitance and the self-inductance per unit length of the transmission line are increased, giving rise to a slow-wave effect. Due to this effect the microstrip device dimension can be significantly reduced. At the same time, it is possible to manipulate the line impedance. The effectiveness regarding the occupied area for a given impedance transformation is illustrated in Table 1.

<table>
<thead>
<tr>
<th>TABLE 1</th>
<th>IMPEDANCE TRANSFORMATION RATIO OF THE EBG STRUCTURE</th>
</tr>
</thead>
<tbody>
<tr>
<td>Transformation ratio</td>
<td>1:2</td>
</tr>
<tr>
<td>Length/λ</td>
<td>0.13</td>
</tr>
<tr>
<td>Width/λ</td>
<td>0.101</td>
</tr>
</tbody>
</table>

$\lambda$ is the wavelength in the substrate material; number of shunt stubs is $n$.

The impedance transformer employing the EBG section is less than quarter wavelength in length and width and can be used for a wide range of impedance ratios. Indeed, it can be seen from Table 1 that different impedance transformation ratios are achieved with different widths $W_p$ in the range of $0.1 \leq \lambda \leq 0.25$, while keeping the length and the number of shunt stubs constant.

The analysis of the proposed structure has been successfully accomplished using well-known transmission line models. The microstrip transmission-line models provide sufficient accuracy for the construction of the EBG structure in the frequency range considered here.

III. BANDPASS FILTER BASED ON COUPLED LINE SECTIONS AND EBG STRUCTURE

The new EBG structure is employed in the design of the bandpass filter shown in Fig. 2. This filter has the same center frequency and bandwidth as that presented in [3]. The filter of [3], however, based on SIH resonator instead of an EBG structure. The SIH resonator implemented in [3] improves the selectivity and eliminates the 2nd-harmonic response of coupled-line sections simultaneously. Filter circuits were implemented on a FR-4 substrate with $\epsilon_r=4.4$ and thickness $h=0.745$ mm. Fig. 3(a) illustrates measured results for the transmission and return loss characteristics of this filter.

The return loss characteristics can be significantly improved by reducing the impedance of the coupled lines and increasing the coupling level. This means that the coupled lines width $(W_c=0.2$ mm) or the separation between the lines $(S=0.2$ mm) have to be reduced even further, which makes the fabrication process more difficult decreases reproducibility.
An alternative way is to change the load of coupled lines by replacing the SIH resonator with the proposed EBG structure, as shown in Fig. 2. In this configuration the load impedance of the coupled lines can easily be adjusted for improved filter matching.

As mentioned above the EBG structure exhibits low-pass characteristics. Due to this fact, the 2nd-harmonic response is effectively suppressed. This is because the EBG as well as the SIH structure give rise to the same parasitic effect to increase the shunt capacitance. The selectivity of the filter at high frequencies is controlled by the EBG sections, whereas the coupled line sections control the low frequency response.

The proposed filter in Fig. 2 is designed using empirical models for single and coupled microstrip lines. Empirical models for coupled microstrip lines are not as accurate as those for single lines [8], since the mutual inductance and the mutual capacitance are not easily predictable.

An accurate prediction of the coupled lines response is carried out using method of moments simulations. The device was fabricated on the same substrate as the traditional filter mentioned above [3].

The EBG structure employed in the filter is three times smaller as compared to the SIH resonator. The new filter has therefore a footprint area reduced by about 30% as compared to the filter proposed in [3]. The overall dimensions of the filter are approximately 0.15λ × 0.27λ, where λ is the guided wavelength in the substrate at center frequency.

Measurement results for the proposed filter and the one discussed in [3] are shown in Fig. 3 and Fig. 4. It can be seen from Fig. 3a that the implementation of the EBG structure in Fig. 1 improves the matching of the device. Also, the 2nd-harmonic response is effectively suppressed. The passband insertion loss is about 1.5 dB, including the connector and the tapped feed line loss. The selectivity of the filter can be defined as

\[
e = \frac{\alpha_{\text{min}} - \alpha_{\text{max}}}{f_s - f_p} \left( \frac{\text{dB}}{\text{GHz}} \right),
\]

where \( f_s \) is the stopband frequency at \( \alpha_{\text{min}} \) with a 20-dB attenuation point, and \( f_p \) is the 3-dB cutoff frequency at \( \alpha_{\text{max}} \) with a 3-dB attenuation point. The lower- and upper-band selectivity of the new bandpass filter is improved to better than 43 dB/GHz and 38 dB/GHz, respectively. The 2nd-harmonic response of the proposed structure is improved from -53 dB to -55.6 dB. The filter has center frequency \( f_0 = 2.3 \) GHz and a first spurious response at about \( 2.7f_0 = 6.2 \) GHz. At this spurious frequency, the minimum insertion loss is found to be 10.5 dB, as shown in Fig. 3b.

The group delay is an important performance aspect for a wide-band filter, especially for filters used for processing of signals with complex frequency content. Fig. 4 shows a plot of the group delay within the filter passband region.

The designed structure achieves a smooth delay pattern in the operating frequency band with a variation of the order of 600 ps. Taking advantage of this property, the device can be effectively used as a component in a variety of systems requiring linear phase characteristics.

The developed filter is intended to be used in a microwave camera for medical applications.

IV. CONCLUSION

The development of microstrip circuits using EBG structures and coupled lines is promising for the development of compact high performance microwave components. A filter has been designed and fabricated for the demonstration of the compactness and improved performance of this method technique. The new filter exhibits improved matching characteristics and suppression of the harmonic response in the stopband. It also reduces the overall geometrical dimensions of the circuit. The fabrication technology is simple, inexpensive, and does not require via-holes or etching in a ground plane. An improvement in the 2nd-harmonic suppression has been achieved reaching a measured value of -55.6 dB. The filter exhibits a 3 dB bandwidth of 45% and an insertion loss of 1.5 dB, a return loss in the passband of better than 25 dB, with good phase linearity, leading to a group delay of ± 300 ps.

REFERENCES